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Paper Submission: <https://edas.info/N29811> or Login EDAS at <http://edas.info/> by selecting "CyberC 2023". Electronic submission to Papers@cyberc.org with a title of "CyberC 2023 Submission" is also accepted.

Become a sponsor or others, contact:

Chi-Ming Chen at chimingchen@ieee.org
Bin Xie: Bin.Xie@Computer.org

EVENTS

Emerging Technology Summit: Co-hosted at Jiangsu with CyberC 2023 and the details will be available.



PRELIMINARY CALL FOR PAPERS

CyberC 2023

The 15th Int. Conference on Cyber-Enabled Distributed Computing and Knowledge Discovery

Suzhou, China, November 02 - 04, 2023, www.Cyberc.org

2023 Theme: **Cyber Computing of AI/ML, Cybersecurity, Image Processing, and Beyond 5G**

Organizer: **Xi'an Jiaotong-Liverpool University**

Co-hosted by: University of Louisville, Nanjing University of Posts & Telecommunications, Zhengzhou University, Guangzhou University, and Computer and Communication Special Committee of Jiansu Computer Society
Sponsored by: ZTE (Diamond), Huawei (Platinum), AT&T, InfoBeyond, Tech Mahindra
Publication: EI, Journal of [Sensor](http://www.mdpi.com) (Special issue)

Scopes: CyberC promotes in-depth exploration of the most recent research and developments in the fields of AI, big data, distributed computing, clouds, cyber security, pervasive computing, mobile computing, Internet of Things, and other cyber-based technologies. Professors, scientists, engineers, and students in these areas are encouraged to participate. CyberC also welcomes industrial participations.

Suzhou: The 15th CyberC will be held in Suzhou, China.

Summits: CyberC 2023 co-hosts **Emerging Technology Summit (AI/ML, Blockchain, Big Data, Image, and 6G)** forum that emphasizes innovative and state-of-art R&D, industry products, specifications, showcases, tutorial, technical transitions, and markets.

Topics: The topics of interests include, but not limited to:

- Big Data, AI and Machine Learning
- Internet of things, localization, and distributed computing
- Blockchain theory and applications
- 6G and mobile computing
- Cyber Image and Surveillance
- Cybersecurity and network monitoring
- Signaling processing and wireless Communications
- IoT and cyber physical systems
- Cloud Computing and mobile services
- HPC and Distributed Computing
- Sensors, ICS, Power grids, and communications

- Cyber security and privacy, cyber trust, cyber agility, and cyber assurance

Co-hosted Workshops: CyberC 2023 incorporates three workshops:

- **Big Data & AI 2023:** The 9th International Workshop on Big Data and Artificial Intelligence
- **Cybersecurity & Blockchain 2023:** The 10th workshop on Cyber Security and Privacy
- **Cyber Image 2023:** The 3rd International Workshop Cyber Image Processing

INFORMATION FOR AUTHORS

The CyberC 2023 Proceedings will be published by CPS. **Full papers** for CyberC 2023 must not exceed 10 pages of 2-column format, while **short papers** must not exceed 4 pages. Please visit the conference web site at <http://www.cyberc.org> for precise formatting and submission instructions.

PAPR SUBMISSION

Submission via [EDAS](http://edas.info/) or submit paper to Papers@CyberC.org

IMPORTANT DATES

Submission deadline: **07/01/2023**
Notification of acceptance: **09/01/2023**
Registration due date: **10/01/2023**
Camera-Ready Paper Submissions and Copyrights Due: **10/01/2023**
Conference date: **11/02/2023-11/04/2023**

SPECIAL ISSUE

<http://cyberc.org/Callforpapers/SpecialIssue>

AUTHOR CONTACTS

papers@cyberc.org

CyberC 2009-2022 Statistics (Average): 13 Keynotes; Number of submissions: 240, Number of accepted papers: 74, Number of Attendees: 130, Number of Sessions: 10.

CyberC 2023 Special Issue: CyberC 2023 provides a special channel for authors to submit your extended version to Journal of Sensors by MDPI:

https://www.mdpi.com/journal/sensors/special_issues/IoT_Wireless_Communications

CyberC WeChat ID: Bin-InfoBeyond

CyberC 2009 - 2022 Proceeding (Accepted papers): [EI](http://www.ieee.org), [IEEE Xplore](http://www.ieee.org), [Google Scholar](http://www.google.com), [Scopus](http://www.scopus.com), [DBLP](http://www.dblp.org)